International **tor** Rectifier

Ultrafast Soft Recovery Diode

Features

- · Ultrafast Recovery
- 175°C Operating Junction Temperature

Benefits

- Reduced RFI and EMI
- Higher Frequency Operation
- Reduced Snubbing
- · Reduced Parts Count

 t_{rr} = 35ns $I_{F(AV)}$ = 60Amp V_R = 200V

60EPU02

60APU02

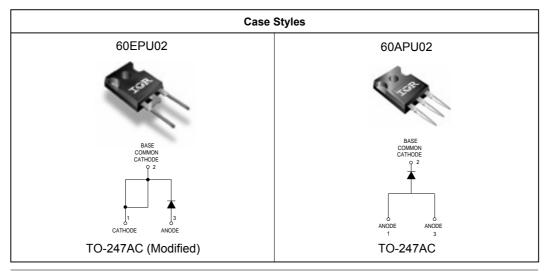
Description/Applications

These diodes are optimized to reduce losses and EMI/ RFI in high frequency power conditioning systems. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

Absolute Maximum Ratings

	Parameters	Max	Units
V _R	Cathode to Anode Voltage	200	V
I _{F(AV)}	Continuous Forward Current, T _C = 127°C	60	А
I _{FSM}	Single Pulse Forward Current, $T_C = 25^{\circ}C$	800	
I _{FRM} ①	Maximum Repetitive Forward Current	120	
T _J , T _{STG}	Operating Junction and Storage Temperatures	- 55 to 175	°C

① Square Wave, 20kHz



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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameters	Min	Тур	Max	Units	Test Conditions
V _{BR} , V _r	Breakdown Voltage, Blocking Voltage	200	-	-	V	I _R = 100μΑ
V _F	Forward Voltage	-	0.98	1.08	V	I _F = 60A
		-	0.81	0.88	V	I _F = 60A, T _J = 175°C
I _R	Reverse Leakage Current	-	-	50	μA	V _R = V _R Rated
		-	-	2	mA	$T_J = 150^{\circ}C$, $V_R = V_R$ Rated
CT	Junction Capacitance	-	87	-	pF	V _R = 200V
L _S	Series Inductance	-	8.0	-	nH	Measured lead to lead 5mm from package body

Dynamic Recovery Characteristics $@T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameters	Min	Тур	Max	Units	Test Conditions			
t _{rr}	Reverse Recovery Time	-	-	35	ns	I _F = 1.0A, di _F /dt = 2	di _F /dt = 200A/µs, V _R = 30V		
		-	28	-		$T_J = 25^{\circ}C$	I _F =60A		
		-	50	-		T _J = 125°C	V _R = 160V di _F /dt = 200A/µs		
I _{RRM}	Peak Recovery Current	-	4	-	A	T _J = 25°C	α _F /α = 200Α/μs		
		-	8	-		T _J = 125°C			
Qrr	Reverse Recovery Charge	-	59	-	nC	T _J = 25°C			
		-	220	-		T _J = 125°C			

Thermal - Mechanical Characteristics

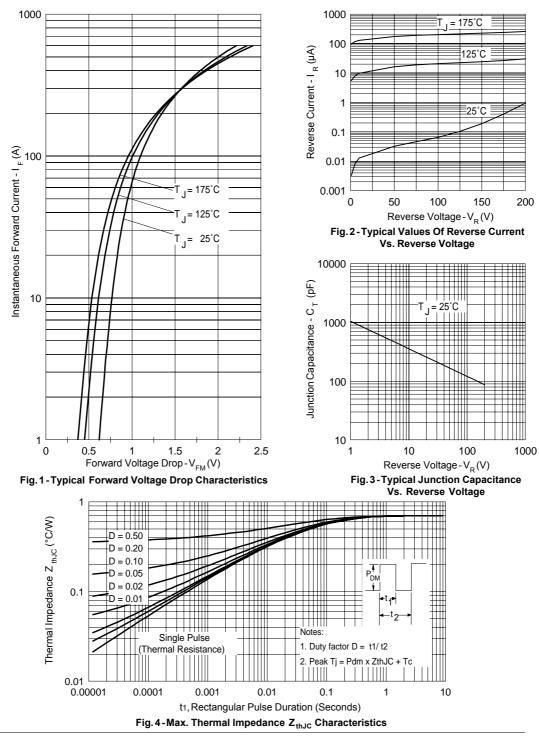
	Parameters	Min	Тур	Max	Units
R _{thJC}	Thermal Resistance, Junction to Case			0.70	K/W
R _{thCS} ②	Thermal Resistance, Case to Heatsink		0.2		
Wt	Weight		5.5		g
			0.2		(oz)
Т	Mounting Torque			1.2	N*m

2 Mounting Surface, Flat, Smooth and Greased

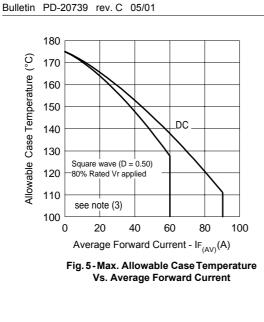
International

60EPU02/ 60APU02

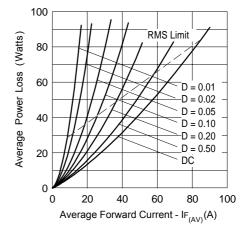


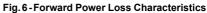


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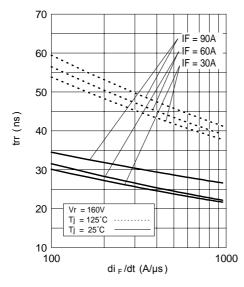


Fig. 7 - Typical Reverse Recovery time vs. di _F/dt

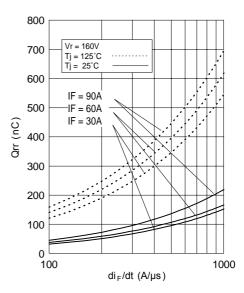


Fig. 8 - Typical Stored Charge vs. di $_{\rm F}/dt$

(3) Formula used: $T_c = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; $Pd = Forward Power Loss = I_{F(AV)} \times V_{FM} @ (I_{F(AV)}/D)$ (see Fig. 6); $Pd_{REV} = Inverse Power Loss = V_{R1} \times I_R (1-D)$; $I_R @ V_{R1} = 80\%$ rated V_R

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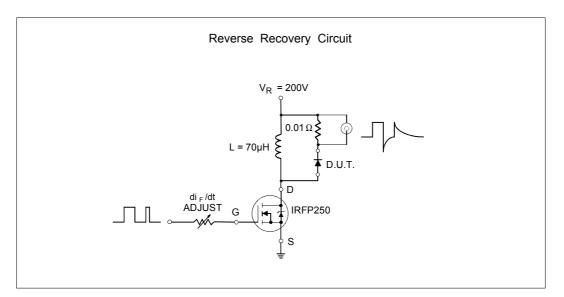


Fig. 9- Reverse Recovery Parameter Test Circuit

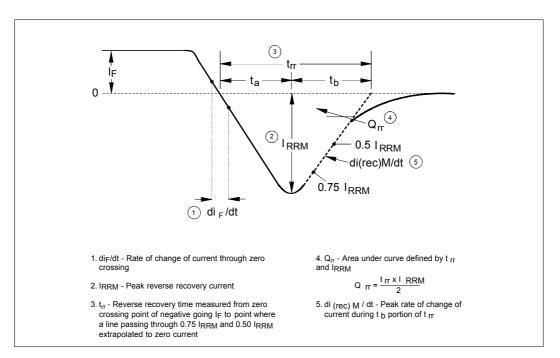


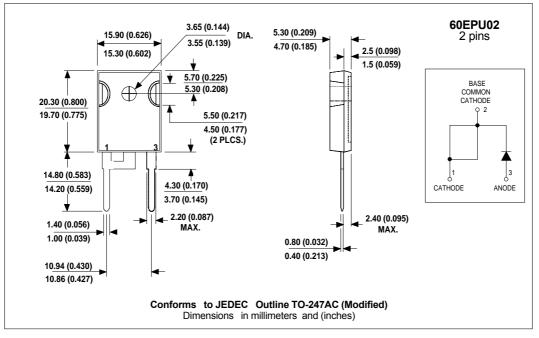
Fig. 10 - Reverse Recovery Waveform and Definitions

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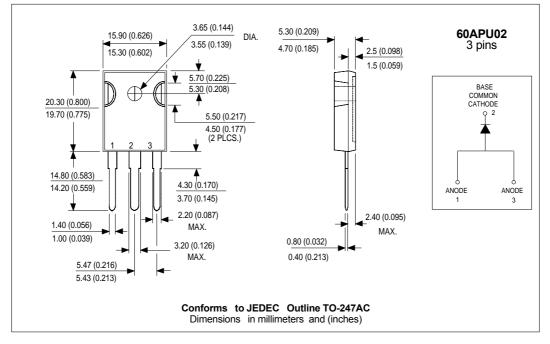
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International

Outline Table



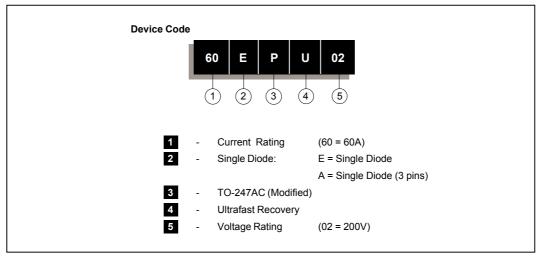
Outline Table



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Ordering Information Table



Data and specifications subject to change without notice. This product has been designed and qualified for Industrial Level. Qualification Standards can be found on IR's Web site.

International

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Vishay

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